

## N-Ch 100V Fast Switching MOSFET VDs=100V, ID=78A, RDS(ON)= $8.0 \text{m}\Omega$

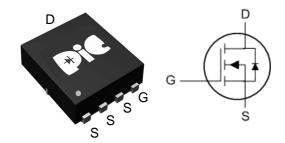
## General Description

This PANOOSY48Y N-Channel enhancement mode power field effect transistor is the high density trench technology and this advanced technology can provide excellent Rds(On) performance and efficiency for power switching and load switching application., this device also comply with the RoHS and Green Product requirement with full function reliability approved.

### > Feature

- Super Low Gate Charge
- ●100% EAS Guaranteed
- •Green Device Available
- ●Excellent CdV/dt effect decline
- Advanced high cell density Trench technology

### DFN5X6A-EP1



## > Application

- ●DC/DC Primary Side Switch
- Industrial Synchronous
- Rectification Load Switch
- ●DC/DC Converters

## > Absolute Maximum Ratings

Parameter	Symbol	Rating	Units
Drain-Source Voltage	V <sub>DS</sub>	100	V
Gate-Source Voltage	V <sub>G</sub> s	±20	V
Continuous Drain Current <sup>1,6</sup>	I <sub>D</sub> @T <sub>C</sub> =25°C	78	А
Continuous Drain Current <sup>1,6</sup>	I <sub>D</sub> @T <sub>C</sub> =70°C	62	Α
Pulsed Drain Current <sup>2</sup>	I <sub>DM</sub>	280	А
Single Pulse Avalanche Energy <sup>3</sup>	EAS	26.5	mJ
Avalanche Current	las	23	А
Total Power Dissipation <sup>4</sup>	P <sub>D</sub> @T <sub>C</sub> =25°C	108	W
Storage Temperature Range	T <sub>STG</sub>	-55 to 150	$^{\circ}$ C
Operating Junction Temperature Range	TJ	-55 to 150	$^{\circ}$ C
Thermal Resistance Junction-Ambient ¹(t≤10s)	Reja	25	°C/W
Thermal Resistance Junction-Ambient <sup>1</sup>	T €JA	55	°C/W
Thermal Resistance Junction-Case <sup>1</sup>	Reлc	1.5	°C/W



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## ➤ Electrical Characteristics (T<sub>J</sub>=25°C Unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	V <sub>GS</sub> =0V , I <sub>D</sub> =250uA	100			V
Static Drain-Source On-Resistance <sup>2</sup>	Prevent	V <sub>GS</sub> =10V , I <sub>D</sub> =13.5A		6.6	8	mΩ
Static Drain-Source On-Resistance <sup>2</sup>	- R <sub>DS(ON)</sub>	V <sub>GS</sub> =4.5V , I <sub>D</sub> =11.5A		8.7	10.5	11122
Gate Threshold Voltage	V <sub>GS(th)</sub>	V <sub>GS</sub> =V <sub>DS</sub> , I <sub>D</sub> =250uA	1.2		2.3	V
Drain-Source Leakage Current	la a a	V <sub>DS</sub> =80V , V <sub>GS</sub> =0V , T <sub>J</sub> =25°C			1	
Dialii-Source Leakage Current	I <sub>DSS</sub>	$V_{DS}=80V$ , $V_{GS}=0V$ , $T_{J}=55^{\circ}C$			5	uA
Gate-Source Leakage Current	Igss	V <sub>GS</sub> =±20V , V <sub>DS</sub> =0V			±100	nA
Forward Transconductance	gfs	V <sub>DS</sub> =5V , I <sub>D</sub> =20A		85		S
Total Gate Charge (10V)	Qg			45		nC
Total Gate Charge (4.5V)	Qg	\/po F0\/ \/oo 40\/ \p 43.5\		19.3		
Gate-Source Charge	Qgs	VDS=50V , VGS=10V , ID=13.5A		9.5		
Gate-Drain Charge	Qgd			4.8		
Turn-On Delay Time	Td(on)			10		
Rise Time	Tr	$V_{DD}$ =50V , $V_{GS}$ =10V , $R_{G}$ =3 $\Omega$ ,		6.5		ns
Turn-Off Delay Time	Td(off)	ID=13.5A		45		
Fall Time	Tf			7.5		
Input Capacitance	Ciss			3320	3984	
Output Capacitance	Coss	VDS=50V , VGS=0V , f=1MHz		605	726	pF
Reverse Transfer Capacitance	Crss			20	24	

## Diode Characteristics

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Continuous Source Current <sup>1,5,6</sup>	Is	V <sub>G</sub> =V <sub>D</sub> =0V , Force Current		-	45	Α
Diode Forward Voltage <sup>2</sup>	$V_{SD}$	$V_{GS}$ =0 $V$ , $I_{S}$ =1 $A$ , $T_{J}$ =25 $^{\circ}$ C			1.1	V
Reverse Recovery Time	t <sub>rr</sub>	IF=13.5A , di/dt=100A/µs ,		33		nS
Reverse Recovery Charge	Qrr	TJ=25°C		150		nC

#### Note:

<sup>1.</sup> Pulse width limited by maximum junction temperature.

<sup>2.</sup>The data tested by pulsed , pulse width  $\leq$  300us , duty cycle  $\leq$  2%

<sup>3.</sup> The EAS data shows Max. rating . The test condition is  $V_{DD}$ =50V,  $V_{GS}$ =10V, L=0.1mH,  $I_{AS}$ =23A

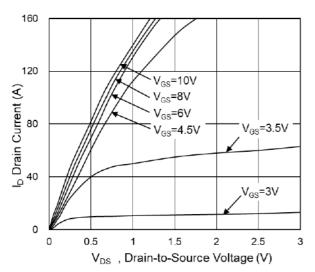
<sup>4.</sup> Ensure that the channel temperature does not exceed 150  $^{\circ}\text{C}.$ 

<sup>5.</sup> The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.



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## > Typical Characteristics



**Fig.1 Typical Output Characteristics** 

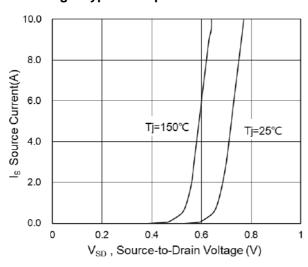


Fig.3 Source-Drain Forward Characteristics

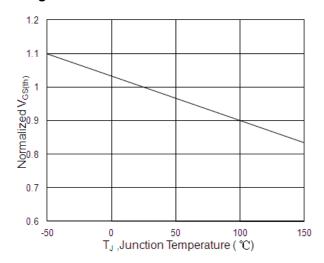


Fig.5 Normalized  $V_{\text{GS(th)}}$  vs  $T_{\text{J}}$ 

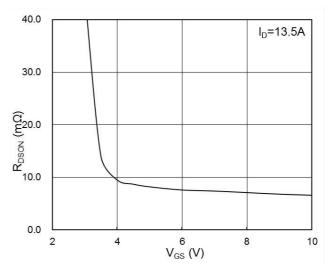


Fig.2 On-Resistance vs G-S Voltage

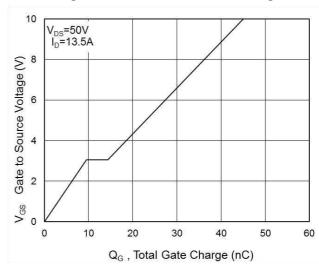


Fig.4 Gate-Charge Characteristics

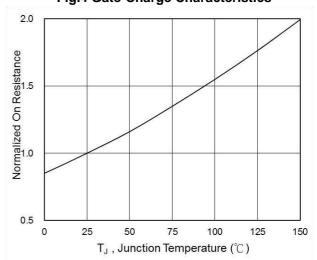
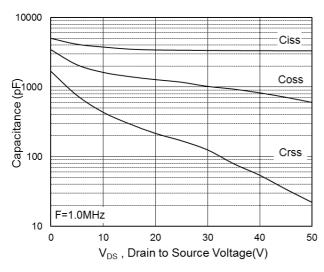


Fig.6 Normalized R<sub>DSON</sub> vs T<sub>J</sub>



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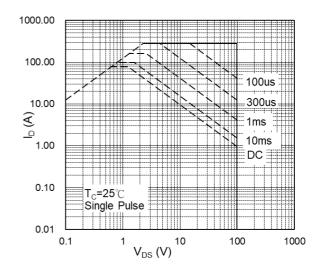


Fig.7 Capacitance

Fig.8 Safe Operating Area

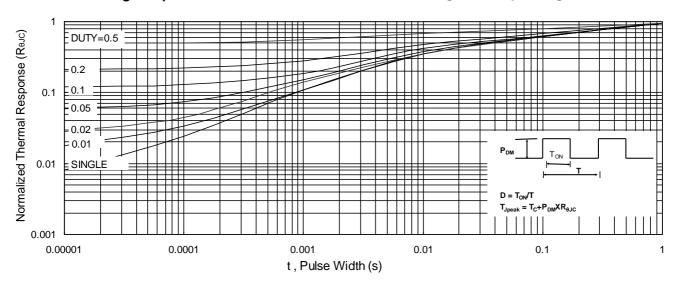


Fig.9 Normalized Maximum Transient Thermal Impedance

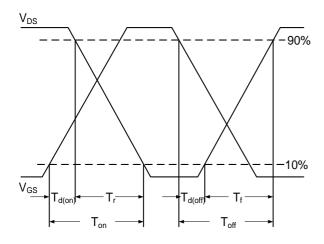


Fig.10 Switching Time Waveform

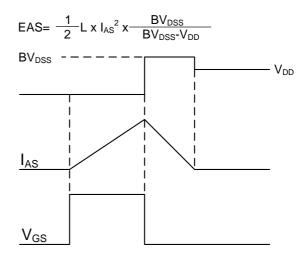
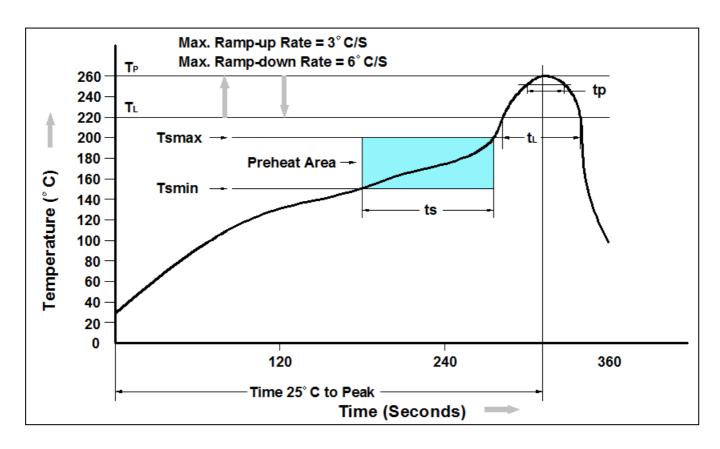


Fig.11 Unclamped Inductive Switching Waveform



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## Recommand IR Reflow Soldering Thermal Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Average Ramp-up Rate (tLto tP)	3°C/second max.
Liquidous Temperature (TL)	217°C
Time (tL) Maintained Above (TL)	60 – 150 seconds
Peak Temperature	260°C +0°C / -5°C
Time (tP) within 5°C of actual Peak Temperature	30 seconds
Ramp-down Rate (TP to TL)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

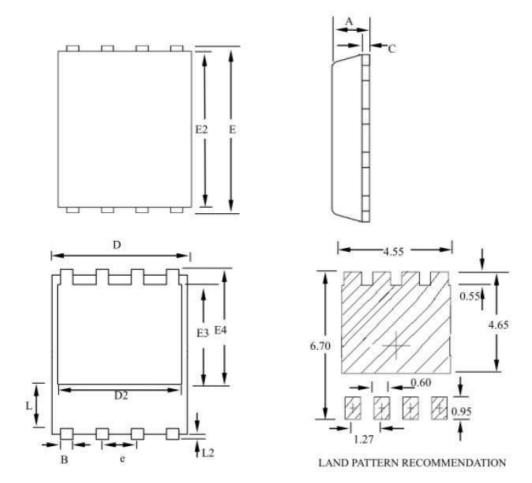
## Ordering Information

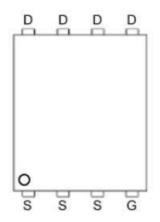
Part Number	Description	Quantity
PAN00SY48Y	DFN5X6A-EP1 Reel	3000 pcs



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## Package Information ( DFN5X6A-EP1 )





SYMBOLS	MILLIMETERS			INCHES		
OT WIDOLO	MIN	NOM	MAX	MIN	NOM	MAX
Α	0.80	555	1.20	0.031	0.775	0.047
В	0.30	(##)	0.51	0.012		0.020
С	0.15	9400 14400	0.35	0.006		0.014
D	4.80	122	5.30	0.189	0220	0.209
D2	3.61	773	4.35	0.142		0.171
Е	5.90	(##)	6.35	0.232		0.250
E2	5.42	(24)	5.90	0.213	1144	0.232
E3	3.23		3.90	0.127		0.154
E4	3.69	(ma)	4.55	0.145		0.179
L	0.61	386)	1.80	0.024		0.071
L2	0.05	(H)	0.36	0.002		0.014
е		1.27			0.050	





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